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# LEADED FERRITE BEADS INDUCTORS



#### FEATURES

- Use of high loss ferrite material.
- Easy mounting on PC boards.
- Available in a wide range of values and configurations to suit most applications.

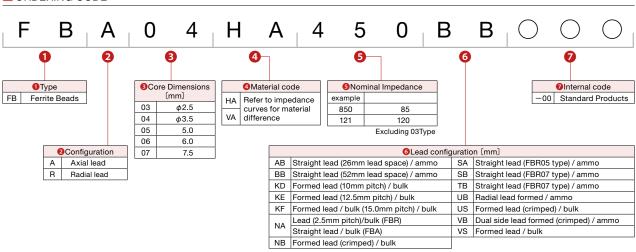
#### ORDERING CODE

#### APPLICATIONS

 Waveform correction of digital signals from digital equipment and absorption of high-frequency noise from data lines.

#### OPERATING TEMP.

● -25°C~85°C



#### EXTERNAL DIMENSIONS/STANDARD QUANTITY



	Configurations			Dimensions		Standard Quantity (pcs)					
	Туре		aping		Bulk	D	L	Туре	Lead	Bulk	Taped
	1	Straight	Formed	Straight	Formed			216.5	Configuration		Ammo
		AB,BB	VB UB	NA		05100	45100		NA, KD, US KE, KF, VS	1000 500	-
	03HA450 -00 03VA450 -00		ฏฏ ฏฏ	_	F: 10, 12.5, 15 (0.39, 0.492, 0.591)	2.5±0.2 (0.098±0.008)	4.5±0.3 (0.177±0.012)	FBA03	AB, BB		2000
		W:26,52 (1.02, 2.05) P:5.0 (0.197)	P: 12.7 (0.500)		VS US F: 5.0 (0.197)	(0.000_0.000)	(0		UB, VB	_	3000
	04HA450□-00 04VA450□-00	AB, BB	VB UB	NA	KD,KE,KF F: 10, 12.5, 15 (0.39, 0.492, 0.591) VS US	3.5±0.2 (0.138±0.008)	4.5±0.3 (0.177±0.012)		NA, KD, US	1000	-
FBA		P:5.0 (0.197)	P: 12.7 (0.500)		F: 5.0 (0.197)						
FDA	04HA600□-00 04VA600□-00	AB,BB	VB	NA	KD,KE,KF	3.5±0.2	$6.0^{+0.5}_{-0}$		KE, KF, VS	500	_
		W:26,52 (1.02, 2.05) P:5.0 (0.197)			F: 10, 12.5, 15 (0.39, 0.492, 0.591)	(0.138±0.008)	(0.236 <sup>+0.020</sup> <sub>-0</sub> )	FBA04	AB, BB	_	1000
		AB,BB	VB		KE,KF						
	04H A900 🗌 -00 04V A900 🗌 -00	W:26,52 (1.02, 2.05) P:5.0 (0.197)	P: 12.7 (0.500)	NA	F: 12.5, 15 (0.492, 0.591)	3.5±0.2 (0.138±0.008)	9.0±0.5 (0.354±0.020)		UB, VB	_	3000
			SA P		NA	5.0 max.	7.5	50005	NA	1000	_
	05VA121 🗌 -00	-	• • P: 12.7 (0.500)	-	F: 2.5 (0.098)	(0.197 max.)	(0.295)	FBR05	SA	_	2000
	06HA850NA-00 06VA850NA-00				NA	6.0±0.5	5.0 (0.197)	55554			
FBR	06HA121NA-00 06VA121NA-00	-	_	-	F: 2.5 (0.098)	(0.236±0.020)	7.0 (0.276)	FBR06	NA	1000	_
	07HA850 🗌 -00 07VA850 🗌 -00		SB,TB		NB	7.5±0.5	5.5 (0.217)	50007	NB	1000	-
	07HA121 -00 07VA121 -00	_	P: 12.7 (0.500)	_	F: 5.0 (0.197)	(0.295±0.020)	7.5 (0.295)	FBR07	SB	_	2000

Note: Lead diameter ( $\phi$ d) shall fall within a range of 0.65mm±0.05mm, FBR05, and FBR07 types however, will have a lead diameter ( $\phi$ d) range of 0.65mm±0.05mm.

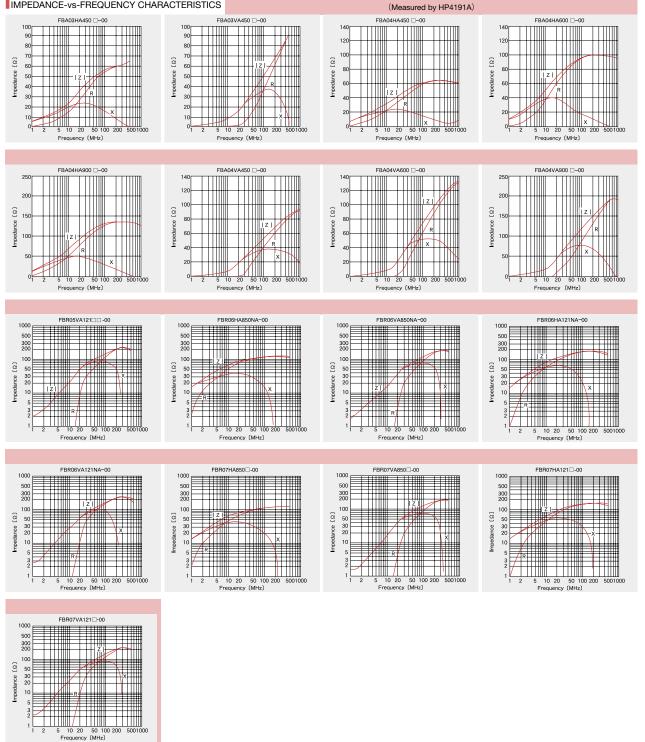
#### PART NUMBERS

		EHS (Environmental	la se	Measuring fre	quency [MHz]	Rated Current [A] max.		
	Ordering code	Hazardous	Impedance [Ω] min.	Mat	erial	Material		
		Substances)	[32] 11111.	HA	VA	HA	VA	
	03 🛆 450 🗌 -00	RoHS	35.0	50	100	7.0	7.0	
FBA	04 🛆 450 🗌 -00	RoHS	45.0	50	100	7.0	7.0	
FBA	04 \( \triangle 00 \( \box) - 00 \)	RoHS	60.0	50	100	7.0	7.0	
	04 \( \Delta 900 \( \Delta -00 \)	RoHS	90.0	50	100	7.0	7.0	
	05 VA 121 🗌 -00	RoHS	120.0	-	100	-	7.0	
	06 △ 850 NA - 00	RoHS	85.0	50	100	7.0	7.0	
FBR	06 △ 121 NA-00	RoHS	120.0	50	100	7.0	7.0	
ļ	07 🛆 850 🗌 -00	RoHS	85.0	50	100	7.0	7.0	
	07 🛆 121 🗌 -00	RoHS	120.0	50	100	7.0	7.0	

rianglePlease specify material codes (HA,VA) and  $\Box$  lead configuration code. %DC Resistance : 0.01 $\Omega$  max., Insulation resistance : 1.0M $\Omega$  min.

#### ELECTRICAL CHARACTERISTICS





#### PACKAGING

#### ①Minimum Quantity

Axial lead (FBA)

(	,					
		Standard quantity [pcs]				
Туре	Lead Configuration	Bulk	Taped			
		Duik	Ammo			
	NA, KD, US	1000	-			
FBA03	KE, KF, VS	500	-			
FBA03	AB, BB	-	2000			
	UB, VB	-	3000			
	NA, KD, US	1000	-			
FBA04	KE, KF, VS	500	-			
FDAU4	AB, BB	-	1000			
	VB, UB	-	3000			

#### Radial lead (FBR)

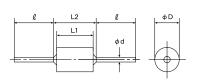
		Standard quantity [pcs]				
Туре	Lead Configuration	Bulk	Taped			
		Buik	Ammo			
FRRAF	NA	1000	-			
FBR05	SA	-	2000			
FBR06	NA	1000	-			
FBR07	NB	1000	_			
FDRU/	SB	-	2000			

#### 2 Bulk dimensions

Axial lead (FBA)

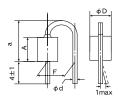
NA

•US



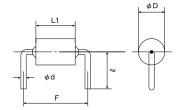
Туре	Dimensions								
Type	φD	L1	L2	φd	l				
FBA03[450	2.5±0.2 (0.098±0.008)	4.5±0.3 (0.177±0.012)	6.5 max. (0.256 max.)		18 min. (0.709 min.)				
FBA04[450]	3.5±0.2 (0.138±0.008)	4.5±0.3 (0.177±0.012)	6.5 max. (0.256 max.)	0.65±0.05					
FBA04[600	3.5±0.2 (0.138±0.008)	6.0 <sup>+0.5</sup> (0.236 <sup>+0.020</sup> <sub>-0</sub> )	8.5 max. (0.335 max.)	(0.026±0.002)					
FBA04[]900	3.5±0.2 (0.138±0.008)	9.0±0.5 (0.354±0.020)	11.0 max. (0.433 max.)						

Unit : mm (inch)



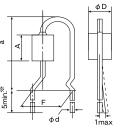
Tune	Dimensions							
Туре	φD	A	а	F	φd			
FBA03[450	2.5±0.2 (0.098±0.008)	4.5±0.3 (0.177±0.012)	9.0 max. (0.354 max.)	5.0±1.0	0.65±0.05 (0.026±0.002)			
FBA04[450]	3.5±0.2 (0.138±0.008)	4.5±0.3 (0.177±0.012)	9.0 max. (0.354 max.)	(0.197±0.039)				
Unit : mm (inch)								

KD/KE/KF



Turne	Lead	Dimensions							
Туре	Symbol	φD F L1		L1	φd	l			
FBA03 450		2.5±0.2 (0.098±0.008)	10.0±1.0 (0.394±0.040)	4.5±0.3 (0.177±0.012)		7.0±2.0 (0.276±0.079			
FBA04[450	KD	3.5±0.2 (0.138±0.008)	10.0±1.0 (0.394±0.040)	4.5±0.3 (0.177±0.012)	0.65±0.05 (0.026±0.020)	7.5±2.0 (0.295±0.079			
FBA04_600		3.5±0.2 (0.138±0.008)	10.0±1.0 (0.394±0.040)	$6.0^{+0.5}_{-0}$ (0.236 <sup>+0.020</sup> )		7.5±2.0 (0.295±0.079			
FBA03 450		2.5±0.2 (0.098±0.008)	12.5±1.0 (0.492±0.004)	4.5±0.3 (0.177±0.012)		7.0±2.0 (0.276±0.079			
FBA04_450	KE	3.5±0.2 (0.138±0.008)	12.5±1.0 (0.492±0.004)	4.5±0.3 (0.177±0.012)	0.65±0.05 (0.026±0.020)	7.5±2.0 (0.295±0.079			
BA04_600		3.5±0.2 (0.138±0.008)	12.5±1.0 (0.492±0.004)	$6.0^{+0.5}_{-0}$ (0.236 <sup>+0.020</sup> <sub>-0</sub> )		7.5±2.0 (0.295±0.079			
BA04_900		3.5±0.2 (0.138±0.008)	12.5±1.0 (0.492±0.004)	9.0±0.5 (0.354±0.020)		7.5±2.0 (0.295±0.079			
FBA03 450		2.5±0.2 (0.098±0.008)	15.0±1.0 (0.591±0.004)	4.5±0.3 (0.177±0.012)		7.0±2.0 (0.276±0.079			
FBA04[450	VE	3.5±0.2 (0.138±0.008)	15.0±1.0 (0.591±0.004)	4.5±0.3 (0.177±0.012)	0.65±0.05	7.5±2.0 (0.295±0.079			
BA04_600	KF	3.5±0.2 (0.138±0.008)	15.0±1.0 (0.591±0.004)	6.0 <sup>+0.5</sup> (0.236 <sup>+0.020</sup> <sub>-0</sub> )	(0.026±0.020)	7.5±2.0 (0.295±0.079			
BA04_900		3.5±0.2 (0.138±0.008)	15.0±1.0 (0.591±0.004)	9.0±0.53 (0.354±0.020)		7.5±2.0 (0.295±0.079			

•vs

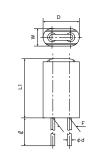


%5±1 for 900 type only

Tune			Dimensions						
Туре	φD A		а	F	φd				
FBA03[450	2.5±0.2	4.5±0.3	12.5 max.	5.0±1.0	0.65±0.05				
	(0.098±0.008)	(0.177±0.012)	(0.492 max.)	(0.197±0.039)	(0.026±0.002)				
FBA04[]450	3.5±0.2	4.5±0.3	12.5 max.	5.0±1.0	0.65±0.05				
	(0.138±0.008)	(0.177±0.012)	(0.492 max.)	(0.197±0.039)	(0.026±0.002)				
FBA04[600	3.5±0.2	$6.0^{+0.5}_{-0}$	12.5 max.	5.0±1.0	0.65±0.05				
	(0.138±0.008)	(0.236 $^{+0.020}_{-0}$ )	(0.492 max.)	(0.197±0.039)	(0.026±0.002)				
FBA04[]900	3.5±0.2	9.0±0.5	16.0 max.	5.0±1.0	0.65±0.05				
	(0.138±0.008)	(0.354±0.020)	(0.630 max.)	(0.197±0.039)	(0.026±0.002)				
	Unit : mm (inch)								

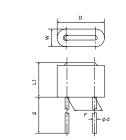
Radial lead (FBR)

NA



Туре	Dimensions								
Type	D	L1	φd	l	W	F			
FBR05VA121	5.0 max. (0.197 max.)	9.0 max. (0.354 max.)	0.65±0.05 (0.026±0.002)	$\substack{10.0^{+3}_{-5}\\ (0.394^{+0.118}_{-0.197})}$	2.5 max. (0.098 max.)	2.5±1.0 (0.098±0.039)			
FBR06[850	6.0±0.5 (0.236±0.020)	7.0 max. (0.276 max.)	0.65±0.05 (0.026±0.002)	$\substack{10.0^{+3}_{-5}\\(0.394^{+0.118}_{-0.197})}$	3.0±0.5 (0.118±0.020)	2.5±1.0 (0.098±0.039)			
FBR06[121 6.0±0.5 (0.236±0.02		9.0 max. (0.354 max.)	0.65±0.05 (0.026±0.002)	${}^{10.0^{+3}_{-5}}_{(0.394^{+0.118}_{-0.197})}$	3.0±0.5 (0.118±0.020)	2.5±1.0 (0.098±0.039)			
	Unit : mm (inch)								

NB

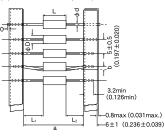


Type	Dimensions							
Type	D	L1	φd	l	W	F		
FBR07[850	7.5±0.5 (0.295±0.020)	7.0 max. (0.276 max.)	0.6±0.05 (0.024±0.002)	5.0 <sup>+1</sup> (0.197 <sup>+0.039</sup> <sub>-0.079</sub> )	2.5 max. (0.098 max.)	5.0 <sup>+1</sup> (0.197 <sup>+0.039</sup> <sub>-0.020</sub> )		
FBR07[121	7.5±0.5 (0.295±0.020)	9.0 max. (0.354 max.)	0.6±0.05 (0.024±0.002)	5.0 <sup>+1</sup> (0.197 <sup>+0.039</sup> <sub>-0.079</sub> )	2.5 max. (0.098 max.)	${\begin{array}{*{20}c} 5.0^{+1}_{-0.5} \\ (0.197^{+0.039}_{-0.020}) \end{array}}$		
				· · · · · · · · · · · · · · · · · · ·	Linit	· mm (inch)		

Unit : mm (inch)

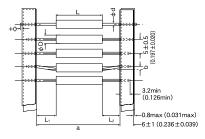
3 Taping Dimensions

AB (a:26mm) (1.02inch lead space)



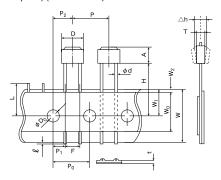
<b>T</b>			Dimer	nsions			Minimum		
Туре	φD	L	а	b	L <sub>1</sub> -L <sub>2</sub>	φd	insertion pitch		
FBA03	2.5±0.2 (0.098±0.008)	4.5±0.3 (0.177±0.012)	$\substack{26.0^{+1.5}_{-0}\\(1.02^{+0.059}_{-0})}$	0.8max (0.031max)	1.0 max (0.039 max)	0.65±0.05 (0.026±0.002)	10.0 (0.394)		
FBA04	3.5±0.2 (0.138±0.008)	4.5±0.3 (0.177±0.012)	$\substack{26.0^{+1.5}_{-0}\\(1.02^{+0.059}_{-0})}$	0.8max (0.031max)	1.0 max (0.039 max)	0.65±0.05 (0.026±0.002)	10.0 (0.394)		
Unit : mm (inch)									

• B (a:52mm) (2.05inches lead space)



-			Dimer	nsions			Minimum		
Туре	φD	L	а	b	L <sub>1</sub> -L <sub>2</sub>	φd	insertion pitch		
FBA03	2.5±0.2 (0.098±0.008)	4.5±0.3 (0.177±0.012)	52.0 <sup>+2</sup> (2.05 <sup>+0.079</sup> <sub>-0.039</sub> )	1.2 max (0.047 max)	1.0 max (0.039 max)	0.65±0.05 (0.026±0.002)	10.0 (0.394)		
FBA04	3.5±0.2 (0.138±0.008)	4.5±0.3 (0.177±0.012)	52.0 <sup>+2</sup> (2.05 <sup>+0.079</sup> <sub>-0.039</sub> )	1.2 max (0.047max)	1.0 max (0.039 max)	0.65±0.05 (0.026±0.002)	10.0 (0.394)		
	Unit : mm (inch)								

• SA (F:2.5mm pitch) (0.098 inches)



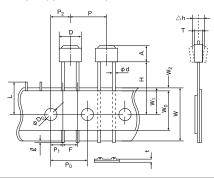
1	Туре	Symbol	Dimensions	Symbol	Dimensions
-		A	121: 9.0 max. (0.354 max.)	w	$\substack{ 18.0^{+1.0}_{-0.5} \\ (0.709^{+0.039}_{-0.020}) }$
		т	2.5 max. (0.098 max.)	Wo	12.5 min. (0.492 min.)
		D	5.0 max. (0.197 max.)	W <sub>1</sub>	$\begin{array}{c}9.0\substack{+0.75\\-0.5}\\(0.354\substack{+0.039\\-0.020})\end{array}$
	FBR05	н	$\substack{18.0^{+2.0}_{-0}\\(0.709^{+0.079}_{-0})}$	W <sub>2</sub>	3.0 max. <sup>**2</sup> (0.118 max.)
		Р	12.7±1.0 (0.500±0.039)	l	1.0 max. (0.039 max.)
		P <sub>0</sub>	12.7±0.3 <sup>**1</sup> (0.500±0.039)	φD₀	4.0±0.3 (0.157±0.012)
		P <sub>1</sub>	5.1±0.7 (0.201±0.028)	φd	0.65±0.05 (0.026±0.002)
		P <sub>2</sub>	6.35±1.3 (0.250±0.051)	L	11.0 max. (0.433 max.)
		F	$2.5^{+1.0}_{-0.5}$ ( $0.098^{+0.039}_{-0.020}$ )	t	0.7±0.2 (0.028±0.008)
		۸h	0.0±2.0		Unit : mm(inch)

(0.0±0.079) \*1 Accumulated error for 20 pitches is ±2mm.

riangle h

 $\$ 2 Bonding tape must not protrude from the base tape.

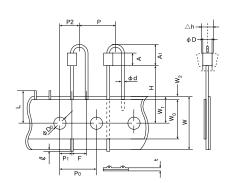
#### • SB/TB (F: 5mm pitch) (0.197 inches)



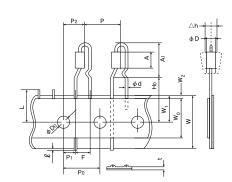
Туре	Symbol	Dimensions	Symbol	Dimensions
	A	121: 9.0 max. (0.354 max.)	∆h	0.0±2.0 (0.0±0.079)
		850: 7.0 max. (0.276 max.)	w	$\substack{18.0^{+1.0}_{-0.5}\\ (0.709^{+0.039}_{-0.020})}$
	т	2.5 max. (0.098 max.)	Wo	12.5 min. (0.492 min.)
	D	7.5±0.5 (0.925±0.020)	W <sub>1</sub>	$\begin{array}{c}9.0\substack{+0.75\\-0.5}\\(0.354\substack{+0.039\\-0.020})\end{array}$
	н	SB: 18.0 <sup>+2.0</sup> (0.709 <sup>+0.079</sup> )	W <sub>2</sub>	3.0 max. <sup>**2</sup> (0.118 max.)
FBR07		TB: 16.0±0.5 (0.630±0.020)	l	1.0 max. (0.039 max.)
	Р	12.7±1.0 (0.500±0.039)	$\phi D_0$	4.0±0.3 (0.157±0.012)
	P <sub>0</sub>	12.7±0.3 <sup>**1</sup> (0.500±0.012)	φd	0.65±0.05 (0.02±0.002)
	P <sub>1</sub>	3.85±0.8 (0.152±0.028)	L	11.0 max. (0.433 max.)
	P <sub>2</sub>	6.35±1.3 (0.250±0.051)	t	0.7±0.2 (0.028±0.008)
	F	$5.0^{+1.0}_{-0.5} \\ (0.197^{+0.039}_{-0.020})$		Unit : mm(inch)

%1 Accumulated error for 20 pitches is ±2mm.
%2 Bonding tape must not protrude from the base tape.

●UB



Туре	Symbol	Dimensions	Symbol	Dimensions
	А	4.5±0.3 (0.177±0.012)	riangle h	0.0±2.0 (0.0±0.079)
	A <sub>1</sub>	9.0 max. (0.354 max.)	w	$18.0^{+1.0}_{-0.5} \\ (0.709^{+0.039}_{-0.020})$
	φD	03: 2.7 max. (0.106 max.)	W <sub>0</sub>	12.5 min. (0.492 min.)
		04: 3.7 max. (0.146 max.)	W <sub>1</sub>	$9.0^{+0.75}_{-0.5} \\ (0.354^{+0.039}_{-0.020})$
FBA03 450	н	$\substack{20.0^{+0.5}_{-1.0}\\(0.787^{+0.020}_{-0.039})}$	W <sub>2</sub>	3.0 max. <sup>#2</sup> (0.118 max.)
FBA04 450	Р	12.7±1.0 (0.500±0.039)	l	1.0 max. (0.039 max.)
	P <sub>0</sub>	12.7±0.3 <sup>**1</sup> (0.500±0.012)	φD₀	4.0±0.3 (0.157±0.012)
	P <sub>1</sub>	3.85±0.8 (0.152±0.032)	φd	0.65±0.05 (0.026±0.002)
	P <sub>2</sub>	6.35±1.3 (0.250±0.051)	L	11.0 max. (0.433 max.)
	F	5.0±1.0 (0.197±0.039)	t	0.7±0.2 (0.028±0.008)
*1 Accumulated error for 20 pitches is ±2mm. Unit : mm (inch)				



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Туре	Symbol	Dimensions	Symbol	Dimensions
		450: 4.5±0.3 (0.177±0.012)	F	5.0±1.0 (0.197±0.039)
	A	$\begin{array}{c} 600:  6.0^{+0.5}_{-0} \\ (0.236^{+0.020}_{-0}) \end{array}$	∆h	0.0±2.0 (0.0±0.079)
		900: 9.0±0.5 (0.354±0.020)	w	$\substack{ 18.0^{+1.0}_{-0.5} \\ (0.709^{+0.039}_{-0.020}) }$
	A <sub>1</sub>	450: 12.5 max. 600: (0.492 max.)	Wo	12.5 min. (0.492 min.)
FBA03 450		900: 16.0 max. (0.630 max.)	W <sub>1</sub>	$9.0^{+0.75}_{-0.5} \\ (0.354^{+0.039}_{-0.020})$
FBA04_450 FBA04_600 FBA04_900	φD	3.7 max. (0.146 max.)	W <sub>2</sub>	3.0 max. <sup>**2</sup> (0.118 max.)
FBA04_900	Ho	16.0±0.5 (0.650±0.020)	l	1.0 max. (0.039 max.)
	Р	12.7±1.0 (0.500±0.039)	$\phi D_0$	4.0±0.3 (0.157±0.012)
	Po	12.7±0.3 <sup>#1</sup> (0.500±0.012)	φd	0.65±0.05 (0.026±0.002)
	P <sub>1</sub>	3.85±0.8 (0.152±0.032)	L	11.0 max. (0.433 max.)
	P <sub>2</sub>	6.35±1.3 (0.250±0.051)	t	0.7±0.2 (0.028±0.008)
**1 Accumulated error for 20 pitches is ±2mm.     Unit : mm (inch)				

%1 Accumulated error for 20 pitches is ±2mm.
%2 Bonding tape must not protrude from the base tape.

%1 Accumulated error for 20 pitches is ±2mm.
%2 Bonding tape must not protrude from the base tape.

RELIABILITY DATA				
1 Operating temperature Bange	1. Operating temperature Range			
	-			
LA Type				
CAL45 Type				
FBA/FBR	−25~+85°C			
FL05 Type				
FL06BT Type	−25~+105°C			
Test Method and Remarks				
LA·CA·FL : Including self-generated h				
2. Storage temperature Range				
LA Type				
CAL45 Type				
	-			
FBA/FBR				
	-			
FL05 Type	_			
FL06BT Type				
0. Detect summent				
3. Rated current				
CAL45 Type	_			
	Within the specified tolerance			
FBA/FBR				
FL05 Type				
FL06BT Type	7			
[Test Method and Remarks]	4			
	aving inductance within 10% and temperature incease within 40°C (LA:20°C) by the application of DC bias.			
	aving inductance decrease within 10% (LHLC08, LHLC10 : within 30%) and temperature increase within the following specified			
temperature by the applic				
Reference temperature :	25°C (LHL08, LHL10, LHL13)			
	30°C (LHL16, LHLP			
	40°C (LHLC08, LHLC10)			
	sarance abnormality by continuous current application for 30 min. Change after the application shall be within $\pm$ 20% of the initial value.			
	relectrial characteristics during current application. Iaving temperature rise within specified value.			
TE . The maximum bo value in				
4. Impedance				
LA Type				
CAL45 Type				
FBA/FBR	Within the specified tolerance			
FL05 Type				
FL06BT Type	Refer to individual specification			
Test Method and Remarks				
	edance analyzer (HP4191A) or its equivalent			
Measuring frequency : Spe				
FL06BT : Measuring equipment : 4291				
Measuring frequency : Spec	cified frequency			
5. Inductance				
	1			
CAL45 Type	Within the specified tolerance			
FBA/FBR				
FL05 Type	Within the specified tolerance			
FL06BT Type				
[Test Method and Remarks]				
	.CR meter (HP4285A + HP42851A or its equivalent)			
Measuring frequency : S				
LHL : Measuring equipment : L	CR meter (HP4285A+HP42851A or its equivalent)			
L	_CR meter (HP4263A) or its equivalent (at 1KHz)			
Measuring frequency : S				
FL05R : Measuring equipment : H				
Measuring frequency : 1	KHZ			
6.0				
6. Q				
	Within the specified tolerance			
CAL45 Type				
FBA/FBR				
FL05 Type				
FL06BT Type				
Test Method and Remarks				
	ter (HP4285A + HP42851A or its equivalent)			
Measuring frequency : Specifier				
	equipment : Equipment : LCR meter (HP4285A+HP42851A or its equivalent)			
,	LCR meter (HP4263A) or its equivalent (at 1kHz)			

Measuring frequency : Specified frequency

7. DC Resis	itance					
LA Type						
CAL45 Type						
FBA/FBR			Within the specified tolerance			
-						
FL05 Type						
FL06BT Type						
Test Metho						
			immeter (A&D AD5812 or its equivalent)			
	FB•FL : Me	easuring equipm	ent : DC ohmmeter			
8. Self resor	nance frequ	iency				
LA Type			Within the specified tolerance			
CAL45 Type						
FBA/FBR						
FL05 Type	9					
FL06BT Type	е					
Test Metho		arks				
			nalyzer (Anritsu MS620J or its equivalent)			
			quipment : (HP4191A, 4192A) its equivalent			
	except Life	r). Weasaning e				
9. Temperat	ture charact	teristic				
LA Type			AL/L: Within ±5%			
CAL45 Type						
			△L/L : Within ±7% (except LHLP16 : Within ±20%)			
FBA/FBR						
FL05 Type	•					
FL06BT Type						
			L			
Test Metho						
LA : Change	e of maximu	um inductance d	eviation in step 1 to 5			
	Step	Ton	nperature (°C)			
		Ten				
	1		20			
	2	—25 (Minimum	operating temperature)			
	3	20 (Stan	dard temperature)			
	4	+85 (Maximur	n operating temperature)			
	5		20			
			20			
	~ ~					
			tance deviation in step 1 to 5			
		re at step 1 : 20				
			inimum operating temperature			
			°C (Standard temperature)			
			aximum operating temperature			
	Temperatu	re at step 5 : 20	C			
10 Terminal	l atranath i	topoilo forco				
-	i strength :	tensile force				
LA Type						
CAL45 Type			No abnormality such as cut lead, or looseness.			
FBA/FBR			No abnormality such as cut lead, or looseness.			
FL05 Type	•		No abnormality such as cut lead, or looseness.			
FL06BT Type	е					
Test Metho	d and Rem	arks				
			ce progressively in the direction to draw terminal.			
••••••						
	force	e (N) di	uration (s)			
	2	5	5			
	L	· L				
CA :	Apply the	stated tensile for	ce progressively in the direction to draw terminal.			
•	force		rration (s)			
		. ,				
	1	U	10			
	Apply the s	stated tensile for	ce progressively in the direction to draw terminal.			
•		I wire diameter t				
		02/14//	0.5 5 5			
		0.3<ød≦0				
		0.5<¢d≦0				
		0.5<¢d≦0 0.8<¢d≦	.2 25			
FBA/FBR :	A bead sha	0.5<¢d≦0 0.8<¢d≦				
		0.5<¢d≦0 0.8<¢d≦ all be fixed and s	.2 25			
		0.5<¢d≦0 0.8<¢d≦ all be fixed and s	.2 25 tatic loaded 20±1N (2.0±0.1 kgf) in axial direction of lead wire in 10±1 seconds.			
FL05R :	Fix the cor	0.5<¢d≦0 0.8<¢d≦ all be fixed and s	.2 25 tatic loaded 20±1N (2.0±0.1 kgf) in axial direction of lead wire in 10±1 seconds.			
FL05R : 11. Over cur	Fix the cor	0.5<¢d≦0 0.8<¢d≦ all be fixed and s	.2 25 tatic loaded 20±1N (2.0±0.1 kgf) in axial direction of lead wire in 10±1 seconds.			
FL05R : 11. Over cur LA Type	Fix the cor	0.5<¢d≦0 0.8<¢d≦ all be fixed and s	.2     25       tatic loaded 20±1N (2.0±0.1 kgf) in axial direction of lead wire in 10±1 seconds.       rection to draw terminal, and gradually apply the tensile force of 4.9N.			
FL05R : 11. Over cur	Fix the cor	0.5<¢d≦0 0.8<¢d≦ all be fixed and s	.2 25 tatic loaded 20±1N (2.0±0.1 kgf) in axial direction of lead wire in 10±1 seconds.			
FL05R : 11. Over cur LA Type CAL45 Type	Fix the cor	0.5<¢d≦0 0.8<¢d≦ all be fixed and s	.2     25       tatic loaded 20±1N (2.0±0.1 kgf) in axial direction of lead wire in 10±1 seconds.       rection to draw terminal, and gradually apply the tensile force of 4.9N.   No emission of smoke no firing. There shall be no scorch or short of wire.			
FL05R : 11. Over cur LA Type	Fix the cor	0.5<¢d≦0 0.8<¢d≦ all be fixed and s	.2     25       tatic loaded 20±1N (2.0±0.1 kgf) in axial direction of lead wire in 10±1 seconds.       rection to draw terminal, and gradually apply the tensile force of 4.9N.			
FL05R : 11. Over cur LA Type CAL45 Type LHL :	Fix the cor	0.5<¢d≦0 0.8<¢d≦ all be fixed and s	.2     25       tatic loaded 20±1N (2.0±0.1 kgf) in axial direction of lead wire in 10±1 seconds.       rection to draw terminal, and gradually apply the tensile force of 4.9N.   No emission of smoke no firing. There shall be no scorch or short of wire.			
FL05R : 11. Over cur LA Type CAL45 Type LHL : FBA/FBR	Fix the cor	0.5<¢d≦0 0.8<¢d≦ all be fixed and s	.2     25       tatic loaded 20±1N (2.0±0.1 kgf) in axial direction of lead wire in 10±1 seconds.       rection to draw terminal, and gradually apply the tensile force of 4.9N.   No emission of smoke no firing. There shall be no scorch or short of wire.			
FL05R   :     11. Over cur     LA Type     CAL45 Type     LHL     FBA/FBR     FL05     Type	Fix the cor	0.5<¢d≦0 0.8<¢d≦ all be fixed and s	.2     25       tatic loaded 20±1N (2.0±0.1 kgf) in axial direction of lead wire in 10±1 seconds.       rection to draw terminal, and gradually apply the tensile force of 4.9N.   No emission of smoke no firing. There shall be no scorch or short of wire.			
FL05R       :         11. Over cur         LA Type         CAL45 Type         LHL         FBA/FBR         FL05       Type         FL06BT Type	Fix the cor rrent	0.5<¢d≦t 0.8<¢d≦ all be fixed and s nponent in the d	.2     25       tatic loaded 20±1N (2.0±0.1 kgf) in axial direction of lead wire in 10±1 seconds.       rection to draw terminal, and gradually apply the tensile force of 4.9N.   No emission of smoke no firing. There shall be no scorch or short of wire.			
FL05R : 11. Over cur LA Type CAL45 Type LHL FBA/FBR FL05 Type FL06BT Type [Test Methor	Fix the cor rrent e e d and Rema	0.5<¢d≦( 0.8<¢d≦ all be fixed and s nponent in the d	.2     25       tatic loaded 20±1N (2.0±0.1 kgf) in axial direction of lead wire in 10±1 seconds.       rection to draw terminal, and gradually apply the tensile force of 4.9N.   No emission of smoke no firing.  There shall be no scorch or short of wire. LHLC08,LHLC10 : There shall be no firing.			
FL05R : 11. Over cur LA Type CAL45 Type LHL FBA/FBR FL05 Type FL06BT Type [Test Methor	Fix the cor rrent e e d and Rema	0.5<¢d≦( 0.8<¢d≦ <sup>*</sup> all be fixed and s nponent in the d	.2       25         tatic loaded 20±1N (2.0±0.1 kgf) in axial direction of lead wire in 10±1 seconds.         rection to draw terminal, and gradually apply the tensile force of 4.9N.         No emission of smoke no firing.         There shall be no scorch or short of wire.         LHLC08,LHLC10 : There shall be no firing.         current       : Rated current×2			
FL05R : 11. Over cur LA Type CAL45 Type LHL FBA/FBR FL05 Type FL06BT Type [Test Methor	Fix the cor rrent e e d and Rema	0.5<¢d≦t 0.8<¢d≦ all be fixed and s nponent in the d	.2     25       tatic loaded 20±1N (2.0±0.1 kgf) in axial direction of lead wire in 10±1 seconds.       rection to draw terminal, and gradually apply the tensile force of 4.9N.   No emission of smoke no firing.  There shall be no scorch or short of wire. LHLC08,LHLC10 : There shall be no firing.			

12. Terminal strength : bending			
LA Туре			
CAL45 Type LHL	No abnormality such as cut lead, or looseness.		
		FL05 Type	
		FL06BT Type	
[Test Method and Bemarks]			

LA, CA : Suspend a mass at the end the terminal, incline the body though angel of 90 and return it to initial position. This operation is done over a period of 2-3 sec. Then sec-ond bend in the opposite direction shall be made. Number of bends : Two times.

Number of beinds . Two times.					
Nominal wire diameter tensile	Bending force	Mass reference weight			
φd (mm)	(N)	(kg)			
0.5<¢d≦0.8	5	0.50			

### LH·FB : Suspend a mass at the end the terminal, incline the body though angel of 90 and return it to initial position. This operation is done over a period of 2-3 sec. Then second bend in the opposite direction shall be made. Number of bends : Two times.

Number of bends . Two times.				
Nominal wire diameter tensile	Bending force	Mass reference weight		
φd (mm)	(N)	(kg)		
0.3<¢d≦0.5	2.5	0.25		
0.5<¢d≦0.8	5	0.5		
0.8<¢d≦1.2	10	1.0		

13. Insulation resisitance : between the	ne terminals and body	
LA Type		
CAL45 Type		
	100MΩ min.	
FBA/FBR		
FL05 Type		
FL06BT Type		
Test Method and Remarks		
LHL	c	
14. Insulation resistance : between te	arminals and sore	
CAL45 Type		
FBA/FBR	1MΩ min. (Other than materail code MA)	
FL05 Type		
FL06BT Type		
[Test Method and Remarks] FBA•FBR: Applied voltage : 100 VDC Duration : 60±5 se		
15 Mitheless dies , hetward the termi		
15. Withstanding : between the termin		
CAL45 Type		
	No abnormality such as insulation damage	
FBA/FBR		
FL05 Type		
FL06BT Type		
LHL : Accoding to JIS C5102. 7. Metal global method Applied voltage : 500 VD Duration : 60 sec.		
16. DC bias characteristic		
LA Type		
CAL45 Type	$-\Delta L/L$ : Within $-10\%$	
FBA/FBR		
FL05 Type		
FL06BT Type		
[Test Method and Remarks] LA, CA : Measure inductance with app	pliation of rated current using LCR meter to compare it with the initial value.	
17. Body strength		
LA Type	No absormality as damage	
CAL45 Type	-No abnormality as damage.	
FBA/FBR	No abnormality such as cracks on body.	
ELOS Type		
FL06BT Type		
Test Method and Remarks		
LA : Applied force : 30N Duration : 10 sec.	o specified force in 2 sec. Press / Pressing jig	
CAL45:Applied force :50N Duration :10 sec. Speed :Shall attain to	o specified force in 2 sec.	
FBA : Applied force : 50±3N Duration : 30±1 sec.		

\* This catalog contains the typical specification only due to the limitation of space. When you consider purchase of our products, please check our specification. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (http://www.ty-top.com/) or CD catalogs.

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	ance to vibration	
LA Type		△L/L : Within ±5% Q : 30min
CAL45 Type	)	△L/L : Within ±5%
LHL		Appearance : No abnomality $\triangle L/L$ : Within $\pm 5\%$ Q change : Within $\pm 30\%$ (LHLP : only $\triangle L/L$ )
FBA/FBR		Appearance : No abnomality Impedance change : Within ±20%
FL05 Type	e	
FL06BT Typ	е	
	od and Remarks	
LA, CA	: Directions	: 2 hrs each in X, Y and Z directions total : 6 hrs.
	Amplitude	: 10 to 55 to 10Hz (1min.) : 1.5mm
		Soldering onto printed board.
	Recovery	At least hir of recovery under the standard condition after the test, followed by the measurement within 2hrs.
LHL	FB : Directions	: 2 hrs each in X, Y and Z directions total : 6 hrs.
	Frequency range Amplitude	: 10 to 55 to 10Hz (1min.) : 1.5mm (But don't exceed acceleration 196m/s <sup>2</sup> (two power))
		: Soldering onto printed board.
	mounting mound	
19. Resista	nce to shock	
_A Type		
CAL45 Type	)	No significant abnormality in appearance
BA/FBR		
L05 Type	9	
LOGET Type		
	od and Remarks	1
	: Drop test	
Impact	t material : concrete or	
Height		
Total n	umber of drops : 10 til	nes
20. Soldera	bility	
A Type	tomty	
A Type CAL45 Type		At least 75% of terminal electrode is covered by new solder.
		At least 75% of terminal electrode is covered by new solder.
BA/FBR	-	At least 90% of terminal electrode is covered by new solder.
FL05 Type		At least 75% of terminal electrode is covered by new solder.
FL06BT Typ		
	od and Remarks	220±5°0
_A, CA :	: Solder temperature : Duration :	250556 2±0.5 sec.
	Duration .	2 ± 0.0 560.
LHL 🗆 🗆 :	: Solder temperature :	235±5℃
		2±0.5 sec.
	Immersion depth :	Up to 1.5mm from bottom of case.
FB :	: Solder temperature :	230+5°
	. oolder temperature .	
	Duration :	3±1 sec.
		3±1 sec. Up to 1.5mm from terminal root.
	Immersion depth :	Up to 1.5mm from terminal root.
FL05R :	Immersion depth : : Solder temperature :	Up to 1.5mm from terminal root. 230±5℃
FL05R :	Immersion depth : Solder temperature : Duration :	Up to 1.5mm from terminal root. 230±5°C 2±0.5 sec.
FL05R :	Immersion depth : Solder temperature : Duration :	Up to 1.5mm from terminal root. 230±5℃
	Immersion depth : Solder temperature : Duration :	Up to 1.5mm from terminal root. 230±5°C 2±0.5 sec. Up to 2 to 2.5mm from terminal root.
	Immersion depth       :         Solder temperature       :         Duration       :         Immersion depth       :         Solder temperature       :         Duration       :         Duration       :         Duration       :	Up to 1.5mm from terminal root. 230±5°C 2±0.5 sec. Up to 2 to 2.5mm from terminal root. 230±5°C 3±1 sec.
	Immersion depth       :         Solder temperature       :         Duration       :         Immersion depth       :         Solder temperature       :         Duration       :         Duration       :         Duration       :	Up to 1.5mm from terminal root. 230±5℃ 2±0.5 sec. Up to 2 to 2.5mm from terminal root. 230±5℃
FL06BT :	Immersion depth       :         Solder temperature       :         Duration       :         Immersion depth       :         Solder temperature       :         Duration       :         Immersion depth       :         Immersion depth       :	Up to 1.5mm from terminal root. 230±5°C 2±0.5 sec. Up to 2 to 2.5mm from terminal root. 230±5°C 3±1 sec.
FL06BT : 21. Resisita	Immersion depth       :         Solder temperature       :         Duration       :         Immersion depth       :         Solder temperature       :         Duration       :         Duration       :         Duration       :	Up to 1.5mm from terminal root. 230±5°C 2±0.5 sec. Up to 2 to 2.5mm from terminal root. 230±5°C 3±1 sec. Up to 0.5 to 1.0mm from terminal root.
FL06BT : 21. Resisita LA Type	Immersion depth : Solder temperature : Duration : Immersion depth : Solder temperature : Duration : Immersion depth : ance to soldering heat	Up to 1.5mm from terminal root. 230±5°C 2±0.5 sec. Up to 2 to 2.5mm from terminal root. 230±5°C 3±1 sec. Up to 0.5 to 1.0mm from terminal root. No significant abnormality in appearance
FL06BT : 21. Resisita LA Type CAL45 Type	Immersion depth : Solder temperature : Duration : Immersion depth : Solder temperature : Duration : Immersion depth : ance to soldering heat	Up to 1.5mm from terminal root. 230±5°C 2±0.5 sec. Up to 2 to 2.5mm from terminal root. 230±5°C 3±1 sec. Up to 0.5 to 1.0mm from terminal root. No significant abnormality in appearance △L/L : Within ±5%
FL06BT : 21. Resisita LA Type CAL45 Type LHL	Immersion depth : Solder temperature : Duration : Immersion depth : Solder temperature : Duration : Immersion depth : ance to soldering heat	Up to 1.5mm from terminal root. 230±5℃ 2±0.5 sec. Up to 2 to 2.5mm from terminal root. 230±5℃ 3±1 sec. Up to 0.5 to 1.0mm from terminal root.
EL06BT : 21. Resisita _A Type CAL45 Type _HL EBA/FBR	Immersion depth : Solder temperature : Duration : Immersion depth : Solder temperature : Duration : Immersion depth : ance to soldering heat	Up to 1.5mm from terminal root. 230±5°C 2±0.5 sec. Up to 2 to 2.5mm from terminal root. 230±5°C 3±1 sec. Up to 0.5 to 1.0mm from terminal root.
21. Resisita A Type CAL45 Type HL	Immersion depth : Solder temperature : Duration : Immersion depth : Solder temperature : Duration : Immersion depth : ance to soldering heat	Up to 1.5mm from terminal root. 230±5°C 2±0.5 sec. Up to 2 to 2.5mm from terminal root. 230±5°C 3±1 sec. Up to 0.5 to 1.0mm from terminal root.
FL06BT : 21. Resisita LA Type CAL45 Type CAL45 Type HLU	Immersion depth : Solder temperature : Duration : Immersion depth : Solder temperature : Duration : Immersion depth : ance to soldering heat	Up to 1.5mm from terminal root. 230±5°C 2±0.5 sec. Up to 2 to 2.5mm from terminal root. 230±5°C 3±1 sec. Up to 0.5 to 1.0mm from terminal root.
21. Resisita LA Type CAL45 Type CAL45 Type FBA/FBR FL05_ Type FL06BT Typ [Test Metho	Immersion depth : Solder temperature : Duration : Immersion depth : Solder temperature : Duration : Immersion depth : ance to soldering heat	Up to 1.5mm from terminal root. $230\pm5^{\circ}C$ $2\pm0.5$ sec.         Up to 2 to 2.5mm from terminal root. $230\pm5^{\circ}C$ $3\pm1$ sec.         Up to 0.5 to 1.0mm from terminal root. $\Delta L/L$ : Within $\pm5\%$ No significant abnormality in appearance $\Delta L/L$ : Within $\pm5\%$ Q change : Within $\pm30\%$ (LHLP : only $\triangle L/L$ )         No significant abnormality in appearance         Inductance change : Within $\pm5\%$ Q change : Within $\pm30\%$ (LHLP : only $\triangle L/L$ )         No significant abnormality in appearance         Impedance change : Within $\pm20\%$ Refer to individual specification         No significant abnormality in appearance         Impedance change : Within $\pm20\%$
21. Resisita A Type CAL45 Type CAL45 Type BA/FBR FBA/FBR FL05_ Type L06BT Typ Test Metho	Immersion depth : Solder temperature : Duration : Immersion depth : Solder temperature : Duration : Immersion depth : ance to soldering heat ance to soldering heat e e b d and Remarks] Solder temperature	Up to 1.5mm from terminal root. 230±5°C 2±0.5 sec. Up to 2 to 2.5mm from terminal root. 230±5°C 3±1 sec. Up to 0.5 to 1.0mm from terminal root.
21. Resisita A Type CAL45 Type CAL45 Type BA/FBR FBA/FBR FL05_ Type L06BT Typ Test Metho	Immersion depth : Solder temperature : Duration : Immersion depth : Solder temperature : Duration : Immersion depth : ance to soldering heat e e e b d and Remarks] Solder temperature Duration	Up to 1.5mm from terminal root. 230±5°C 2±0.5 sec. Up to 2 to 2.5mm from terminal root. 230±5°C 3±1 sec. Up to 0.5 to 1.0mm from terminal root. No significant abnormality in appearance △L/L : Within ±5% No significant abnormality in appearance △L/L : Within ±5% No significant abnormality in appearance Inductance change : Within ±5% Q change : Within ±30%(LHLP : only △L/L) No significant abnormality in appearance Refer to individual specification No significant abnormality in appearance Impedance change : Within ±20%
21. Resisita A Type CAL45 Type CAL45 Type BA/FBR FBA/FBR FL05_ Type L06BT Typ Test Metho	Immersion depth : Solder temperature : Duration : Immersion depth : Solder temperature : Duration : Immersion depth : ance to soldering heat e e dand Remarks] Solder temperature Duration Immersed conditions	Up to 1.5mm from terminal root. 230±5°C 2±0.5 sec. Up to 2 to 2.5mm from terminal root. 230±5°C 3±1 sec. Up to 0.5 to 1.0mm from terminal root. No significant abnormality in appearance △L/L : Within ±5% No significant abnormality in appearance No significant abnormalit
FL06BT : 21. Resisita LA Type CAL45 Type CAL45 Type HL FBA/FBR FL05 Type FL06BT Typ [Test Metho LA, CA :	Immersion depth : Solder temperature : Duration depth : Solder temperature : Duration : Immersion depth : Immersion depth : ance to soldering heat ance to soldering heat solder temperature Duration Immersed conditions Recovery	Up to 1.5mm from terminal root. 230±5°C 2±0.5 sec. Up to 2 to 2.5mm from terminal root. 230±5°C 3±1 sec. Up to 0.5 to 1.0mm from terminal root. No significant abnormality in appearance △L/L : Within ±5% No significant abnormality in appearance Inductance change : Within ±5% Q change : Within ±30%(LHLP : only △L/L) No significant abnormality in appearance Impedance change : Within ±20% Refer to individual specification No significant abnormality in appearance Impedance change : Within ±20% : (CA) 270±5°C, (LA) 260±5°C : 5±0.5 sec. One time : Inserted into substrate with t=1.6mm : At least 1hr of recovery under the standard condition after the test, followed by the measurement within 2hrs.
FL06BT : 21. Resisita LA Type CAL45 Type CAL45 Type HL FBA/FBR FL05 Type FL06BT Typ [Test Metho LA, CA :	Immersion depth : Solder temperature : Duration depth : Solder temperature : Duration : Immersion depth : Immersion depth : ance to soldering heat ance to soldering heat solder temperature Duration Immersed conditions Recovery	Up to 1.5mm from terminal root. 230±5°C 2±0.5 sec. Up to 2 to 2.5mm from terminal root. 230±5°C 3±1 sec. Up to 0.5 to 1.0mm from terminal root. No significant abnormality in appearance △L/L : Within ±5% No significant abnormality in appearance △L/L : Within ±5% No significant abnormality in appearance Mpedance change : Within ±20% Refer to individual specification No significant abnormality in appearance Inductance change : Within ±20% Refer to individual specification No significant abnormality in appearance Impedance change : Within ±20% Refer to individual specification No significant abnormality in appearance Impedance change : Within ±20% (CA) 270±5°C, (LA) 260±5°C 5±0.5 sec. One time Inserted into substrate with t=1.6mm : At least 1hr of recovery under the standard condition after the test, followed by the measurement within 2hrs. : Solder temperature : 260±5°C
FL06BT : 21. Resisita LA Type CAL45 Type CAL45 Type HL FBA/FBR FL05 Type FL06BT Typ [Test Metho LA, CA :	Immersion depth : Solder temperature : Duration depth : Solder temperature : Duration : Immersion depth : Immersion depth : ance to soldering heat ance to soldering heat solder temperature Duration Immersed conditions Recovery	Up to 1.5mm from terminal root. 230±5°C 2±0.5 sec. Up to 2 to 2.5mm from terminal root. 230±5°C 3±1 sec. Up to 0.5 to 1.0mm from terminal root. No significant abnormality in appearance △L/L : Within ±5% No significant abnormality in appearance Inductance change : Within ±5% Q change : Within ±30%(LHLP : only △L/L) No significant abnormality in appearance Impedance change : Within ±20% Refer to individual specification No significant abnormality in appearance Impedance change : Within ±20% (CA) 270±5°C, (LA) 260±5°C 5±0.5 sec. One time : Inserted into substrate with t=1.6mm : At least 1hr of recovery under the standard condition after the test, followed by the measurement within 2hrs. : Solder temperature : 260±5°C Duration : 10±1 sec.
FL06BT : 21. Resisita LA Type CAL45 Type CAL45 Type HL FBA/FBR FL05 Type FL06BT Typ [Test Metho LA, CA :	Immersion depth : Solder temperature : Duration : Immersion depth : Solder temperature : Duration : Immersion depth : ance to soldering heat ance to soldering heat solder temperature Duration Immersed conditions Recovery Solder bath method	Up to 1.5mm from terminal root. 230±5°C 2±0.5 sec. Up to 2 to 2.5mm from terminal root. 230±5°C 3±1 sec. Up to 0.5 to 1.0mm from terminal root. No significant abnormality in appearance △L/L : Within ±5% No significant abnormality in appearance Inductance change : Within ±5% Q change : Within ±30%(LHLP : only △L/L) No significant abnormality in appearance Impedance change : Within ±20% Refer to individual specification No significant abnormality in appearance Impedance change : Within ±20% (CA) 270±5°C, (LA) 260±5°C 5±0.5 sec. One time : Inserted into substrate with 1=1.6mm : At least 1hr of recovery under the standard condition after the test, followed by the measurement within 2hrs. : Solder temperature : 260±5°C Duration : 10±1 sec. Up to 1.5mm from bottom of case.
FL06BT : 21. Resisita LA Type CAL45 Type CAL45 Type HL FBA/FBR FL05 Type FL06BT Typ [Test Metho LA, CA :	Immersion depth : Solder temperature : Duration : Immersion depth : Solder temperature : Duration : Immersion depth : ance to soldering heat ance to soldering heat solder temperature Duration Immersed conditions Recovery Solder bath method	Up to 1.5mm from terminal root. 230±5°C 2±0.5 sec. Up to 2 to 2.5mm from terminal root. 230±5°C 3±1 sec. Up to 0.5 to 1.0mm from terminal root. No significant abnormality in appearance △L/L : Within ±5% No significant abnormality in appearance Inductance change : Within ±5% Q change : Within ±30%(LHLP : only △L/L) No significant abnormality in appearance Impedance change : Within ±20% Refer to individual specification No significant abnormality in appearance Impedance change : Within ±20% (CA) 270±5°C, (LA) 260±5°C 5±0.5 sec. One time : Inserted into substrate with t=1.6mm : At least 1hr of recovery under the standard condition after the test, followed by the measurement within 2hrs. : Solder temperature : 260±5°C Duration : 10±1 sec.
21. Resisita           A Type           CAL45 Type           CAL45 Type           BA/FBR           FL0.6BT Type           L0.6BT Type	Immersion depth : Solder temperature : Duration : Immersion depth : Solder temperature : Duration : Immersion depth : ance to soldering heat ance to soldering heat solder temperature Duration Immersed conditions Recovery Solder bath method	Up to 1.5mm from terminal root. 230±5°C 2±0.5 sec. Up to 2 to 2.5mm from terminal root. 230±5°C 3±1 sec. Up to 0.5 to 1.0mm from terminal root. No significant abnormality in appearance △L/L : Within ±5% No significant abnormality in appearance Modula specification No significant abnormality in appearance No
21. Resisita           A Type           CAL45 Type           CAL45 Type           BA/FBR           FL0.6BT Type           L0.6BT Type	Immersion depth : Solder temperature : Duration : Immersion depth : Solder temperature : Duration : Immersion depth : ance to soldering heat dand Remarks] Solder temperature Duration Immersed conditions Recovery Solder bath method Manual soldering Caution	Up to 1.5mm from terminal root. 230±5°C 2±0.5 sec. Up to 2 to 2.5mm from terminal root. 230±5°C 3±1 sec. Up to 0.5 to 1.0mm from terminal root. No significant abnormality in appearance △L/L : Within ±5% No significant abnormality in appearance Inductance change : Within ±5% No significant abnormality in appearance Inductance change : Within ±20% Refer to individual specification No significant abnormality in appearance Impedance change : Within ±20% (CA) 270±5°C, (LA) 260±5°C 5±0.5 sec. One time Inserted into substrate with t=1.6mm At least 1hr of recovery under the standard condition after the test, followed by the measurement within 2hrs. Solder temperature : 260±5°C Duration : 10±1 sec. Up to 1.5mm from bottom of case. Solder temperature : 250±10°C (At the tip of soldering iron) Duration : 5±1 sec. Up to 1.5mm from bottom of case. No excessive pressing shall be applied to terminald.
FL06BT : 21. Resisita LA Type CAL45 Type CAL45 Type IHL FBA/FBR FL05 Type FL06BT Typ [Test Metho LA, CA :	Immersion depth : Solder temperature : Duration : Immersion depth : Solder temperature : Duration : Immersion depth : ance to soldering heat dand Remarks] Solder temperature Duration Immersed conditions Recovery Solder bath method Manual soldering Caution	Up to 1.5mm from terminal root. 230±5°C 2±0.5 sec. Up to 2 to 2.5mm from terminal root. 230±5°C 3±1 sec. Up to 0.5 to 1.0mm from terminal root. No significant abnormality in appearance △L/L : Within ±5% No significant abnormality in appearance No significant abnormality in appearance No significant abnormality in appearance
FL06BT         :           21. Resisita           LA Type           CAL45 Type           CAL45 Type           FBA/FBR           FL06BT Type           [Test Metholar Comparison of the second of t	Immersion depth : Solder temperature : Duration : Immersion depth : Solder temperature : Duration : Immersion depth : Immersion depth : ance to soldering heat conder temperature Duration Immersed conditions Recovery Solder bath method Manual soldering Caution Recovery	Up to 1.5mm from terminal root. 230±5℃ 2±0.5 sec. Up to 2 to 2.5mm from terminal root. 230±5℃ 3±1 sec. Up to 0.5 to 1.0mm from terminal root. No significant abnormality in appearance △L/L : Within ±5% No significant abnormality in appearance Inductance change : Within ±5% Q change : Within ±30%(LHLP : only △L/L) No significant abnormality in appearance Impedance change : Within ±20% Refer to individual specification No significant abnormality in appearance Impedance change : Within ±20% (CA) 270±5℃, (LA) 260±5℃ 5±0.5 sec. One time : Inserted into substrate with t=1.6mm : At least 1hr of recovery under the standard condition after the test, followed by the measurement within 2hrs. : Solder temperature : 260±5℃ Duration : 10±1 sec. Up to 1.5mm from bottom of case. : Solder temperature : 350±1℃ (At the tip of soldering iron) Duration : 5±1 sec. Up to 1.5mm from bottom of case. : No excessive pressing shall be applied to terminald. : A to 24hrs of recovery under the standard condition after the test.
FL06BT         :           21. Resisita           LA Type           CAL45 Type           CAL45 Type           FBA/FBR           FL06BT Type           [Test Metho           LA, CA           LHL	Immersion depth : Solder temperature : Duration : Immersion depth : Solder temperature : Duration : Immersion depth : Immersion depth : ance to soldering heat conder temperature Duration Immersed conditions Recovery Solder bath method Manual soldering Caution Recovery	Up to 1.5mm from terminal root. 230±5℃ 2±0.5 sec. Up to 2 to 2.5mm from terminal root. 230±5℃ 3±1 sec. Up to 0.5 to 1.0mm from terminal root. No significant abnormality in appearance △L/L : Within ±5% No significant abnormality in appearance Inductance change : Within ±5% Q change : Within ±30%(LHLP : only △L/L) No significant abnormality in appearance Impedance change : Within ±20% Refer to individual specification No significant abnormality in appearance Impedance change : Within ±20% (CA) 270±5℃, (LA) 260±5℃ : (CA) 270±5℃, (LA) 260±5℃ : (Solder temperature : 260±5℃ Duration : 10±1 sec. Up to 1.5mm from bottom of case. : Solder temperature : 350±10℃ (At the tip of soldering iron) Duration : 5±1 sec. Up to 1.5mm from bottom of case. : Solder temperature : 350±10℃ (At the tip of soldering iron) Duration : 5±1 sec. Up to 1.5mm from bottom of case. : Solder temperature : 350±10℃ (At the tip of soldering iron) Duration : 5±1 sec. Up to 1.5mm from bottom of case. : Solder temperature : 350±10℃ (At the tip of soldering iron) Duration : 5±1 sec. Up to 1.5mm from bottom of case. : Solder temperature : 250±5℃ : Solder temperature : 250±15℃ : Condition 1 : Solder temperature : 260±5℃
FL06BT         :           21. Resisita           LA Type           CAL45 Type           CAL45 Type           FBA/FBR           FL06BT Type           [Test Metholar Comparison of the second of t	Immersion depth : Solder temperature : Duration : Immersion depth : Solder temperature : Duration : Immersion depth : Immersion depth : ance to soldering heat conder temperature Duration Immersed conditions Recovery Solder bath method Manual soldering Caution Recovery	Up to 1.5mm from terminal root. 230±5℃ 2±0.5 sec. Up to 2 to 2.5mm from terminal root. 230±5℃ 3±1 sec. Up to 0.5 to 1.0mm from terminal root. No significant abnormality in appearance △L/L : Within ±5% No significant abnormality in appearance △L/L : Within ±5% No significant abnormality in appearance Inductance change : Within ±5% Q change : Within ±30%(LHLP : only △L/L) No significant abnormality in appearance Impedance change : Within ±20% Refer to individual specification No significant abnormality in appearance Impedance change : Within ±20% Refer to individual specification No significant abnormality in appearance Impedance change : Within ±20% : (CA) 270±5℃, (LA) 260±5℃ 5±0.5 sec. One time : Inserted into substrate with t=1.6mm : At least 1hr of recovery under the standard condition after the test, followed by the measurement within 2hrs. : Solder temperature : 260±5℃ Duration : 5±1 sec. Up to 1.5mm from bottom of case. : Solder temperature : 350±10℃ (At the tip of soldering iron) Duration : 5±1 sec. Up to 1.5mm from bottom of case. : No excessive pressing shall be applied to terminald. : 4 to 24hrs of recovery under the standard condition after the test. : Condition 1 : Solder temperature : 260±5℃ Duration : 10±1 sec.
FL06BT         :           21. Resisita           LA Type           CAL45 Type           LHL           FBA/FBR           FL06BT Type           Test Metho           LA, CA           LHL	Immersion depth : Solder temperature : Duration : Immersion depth : Solder temperature : Duration : Immersion depth : Immersion depth : ance to soldering heat conder temperature Duration Immersed conditions Recovery Solder bath method Manual soldering Caution Recovery	Up to 1.5mm from terminal root. 230±5℃ 2±0.5 sec. Up to 2 to 2.5mm from terminal root. 230±5℃ 3±1 sec. Up to 0.5 to 1.0mm from terminal root. No significant abnormality in appearance △L/L : Within ±5% No significant abnormality in appearance △L/L : Within ±5% No significant abnormality in appearance Inductance change : Within ±5% Q change : Within ±30%(LHLP : only △L/L) No significant abnormality in appearance Impedance change : Within ±20% Refer to individual specification No significant abnormality in appearance Impedance change : Within ±20% (CA) 270±5℃, (LA) 260±5℃ : 5±0.5 sec. : Solder temperature : 260±5℃ Duration : 10±1 sec. Up to 1.5mm from bottom of case. : Solder temperature : 350±10℃ (At the tip of soldering iron) Duration : 10±1 sec. Up to 1.5mm from bottom of case. : Solder temperature : 350±10℃ (At the tip of soldering iron) Duration : 10±1 sec. Up to 1.5mm from bottom of case. : Solder temperature : 350±10℃ (At the tip of soldering iron) Duration : 10±1 sec. Up to 1.5mm from bottom of case. : Solder temperature : 350±10℃ (At the tip of soldering iron) Duration : 10±1 sec. Up to 1.5mm from bottom of case. : Solder temperature : 260±5℃ : Condition 1 : Solder temperature : 260±5℃
FL06BT         :           21. Resisita           LA Type           CAL45 Type           LHL           FBA/FBR           FL06BT Type           Test Metho           LA, CA           LHL	Immersion depth : Solder temperature : Duration : Immersion depth : Solder temperature : Duration : Immersion depth : Immersion depth : ance to soldering heat conder temperature Duration Immersed conditions Recovery Solder bath method Manual soldering Caution Recovery	Up to 1.5mm from terminal root. 230±5°C 2±0.5 sec. Up to 2 to 2.5mm from terminal root. 230±5°C 3±1 sec. Up to 0.5 to 1.0mm from terminal root. No significant abnormality in appearance AL/L : Within ±5% No significant abnormality in appearance Inductance change : Within ±5% Q change : Within ±30%(LHLP : only △L/L) No significant abnormality in appearance Impedance change : Within ±20% Refer to individual specification No significant abnormality in appearance Impedance change : Within ±20% Refer to individual specification No significant abnormality in appearance Impedance change : Within ±20% Refer to individual specification Refer to individual specification No significant abnormality in appearance Impedance change : Within ±20% Refer to individual specification Refer to individual specification No significant abnormality in appearance Impedance change : Within ±20% Refer to individual specification No significant abnormality in appearance Impedance change : Within ±20% Refer to individual specification No significant abnormality in appearance Impedance change : Within ±20% Refer to individual specification No significant abnormality in appearance Impedance change : Within ±20% Refer to individual specification No significant abnormality in appearance Impedance change : Within ±20% Refer to individual specification Refer to indit substrate with t=1.6mm Refer to individual specificat
FL06BT         :           21. Resisita           LA Type           CAL45 Type           CAL45 Type           FBA/FBR           FL06BT Type           [Test Metholar Comparison of the second of t	Immersion depth : Solder temperature : Duration depth : Solder temperature : Duration depth : Immersion depth : Immersion depth : ance to soldering heat ance to soldering heat b ance to soldering heat ance to soldering heat ance to soldering heat b ance to soldering heat ance to soldering b ance to solder bath method Manual soldering Caution Recovery Solder bath method	Up to 1.5mm from terminal root. 230±5°C 2±0.5 sec. Up to 2 to 2.5mm from terminal root. 230±5°C 3±1 sec. Up to 0.5 to 1.0mm from terminal root. No significant abnormality in appearance △L/L : Within ±5% No significant abnormality in appearance △L/L : Within ±5% No significant abnormality in appearance △L/L : Within ±5% No significant abnormality in appearance Inductance change : Within ±5% Q change : Within ±30%(LHLP : only △L/L) No significant abnormality in appearance Impedance change : Within ±20% Refer to individual specification Refer to individual specification (CA) 270±5°C, (LA) 260±5°C 5±0.5 sec. One time : Inserted into substrate with t=1.6mm : At least thr of recovery under the standard condition after the test, followed by the measurement within 2hrs. : Solder temperature : 260±5°C Duration : 10±1 sec. Up to 1.5mm from bottom of case. : Solder temperature : 350±10°C (At the tip of soldering iron) Duration : 5±1 sec. Up to 1.5mm from bottom of case. : Solder temperature : 350±10°C (At the tip of soldering iron) Duration : 5±1 sec. Up to 1.5mm from bottom of case. : Solder temperature : 260±5°C Duration : 10±1 sec. : No excessive pressing shall be applied to terminald. : 4 to 24hrs of recovery under the standard condition after the test. : Condition 1 : Solder temperature : 260±5°C Duration : 10±1 sec. : Immersion depth : Up to 1.5mm from terminal root. Condition 2 : Solder temperature : 260±5°C Duration : 3±1 sec. Immersion depth : Up to 1.5mm from terminal root.
FL06BT         :           21. Resisita           LA Type           CAL45 Type           CAL45 Type           FBA/FBR           FL06BT Type           [Test Metho           LA, CA           LHL	Immersion depth : Solder temperature : Duration depth : Solder temperature : Duration depth : Immersion depth : Immersion depth : ance to soldering heat ance to soldering heat b ance to soldering heat ance to soldering heat ance to soldering heat b ance to soldering heat ance to soldering b ance to solder bath method Manual soldering Caution Recovery Solder bath method	Up to 1.5mm from terminal root. 230±5°C 21:0.5 sec. Up to 2:0:5 to 2.5mm from terminal root. 230±5°C 3:1 sec. Up to 5: to 1.0mm from terminal root. 230±5°C 3:1 sec. Up to 5: to 1.0mm from terminal root. No significant abnormality in appearance Inductance change : Within ±5% Q change : Within ±30%(LHLP : only △L/L) No significant abnormality in appearance Impedance change : Within ±20% Refer to individual specification No significant abnormality in appearance Impedance change : Within ±20% Refer to individual specification No significant abnormality in appearance Impedance change : Within ±20% : (CA) 270±5°C, (LA) 260±5°C : 5±0.5 sec. One time : Inserted into substrate with t=1.6mm : At least 1hr of recovery under the standard condition after the test, followed by the measurement within 2hrs. : Solder temperature : 260±5°C Duration : 0±1 sec. Up to 1.5mm from bottom of case. : Solder temperature : 350±10°C (At the tip of soldering iron) Duration : 5±1 sec. Up to 1.5mm from bottom of case. : No excessive pressing shall be applied to terminald. : 4 to 24hrs of recovery under the standard condition after the test. : Condition 1 : Solder temperature : 260±5°C Duration : 10±1 sec. : Condition 1 : Solder temperature : 260±5°C : Duration : 10±1 sec. : Condition 1 : Solder temperature : 260±5°C : Duration : 10±1 sec. : Immersion depth : Up to 1.5mm from terminal root. : Condition 2 : Solder temperature : 260±5°C : Duration : 10±1 sec. : Immersion depth : Up to 1.5mm from terminal root. : Condition 2 : Solder temperature : 260±5°C : Duration : 10±1 sec. : Immersion depth : Up to 1.5mm from terminal root. : Condition 2 : Solder temperature : 260±5°C : Duration : 3±1 sec.
FL06BT       :         21. Resisita         LA Type         CAL45 Type         CAL45 Type         FBA/FBR         FL05E         FL05ET         Test Metho         LA, CA         LHL         FB         FB	Immersion depth : Solder temperature : Duration depth : Solder temperature : Duration depth : Immersion depth : Immersion depth : ance to soldering heat Immersion depth : ance to soldering heat Be Be Be Be Be Be Be Be Be Be Be Be Be	Up to 1.5mm from terminal root. 230.5 \$C 210.5 sec. Up to 2 to 2.5mm from terminal root. 230.5 \$C 331 sec. Up to 0.5 to 1.0mm from terminal root. 230.5 \$C 341 sec. Up to 0.5 to 1.0mm from terminal root. 230.5 \$C 240.5 \$C 24
FL06BT       :         21. Resisita         LA Type         CAL45 Type         CAL45 Type         FBA/FBR         FL05E         FL05ET         Test Metho         LA, CA         LHL         FB         FB	Immersion depth : Solder temperature : Duration depth : Solder temperature : Duration depth : Duration depth : Immersion depth : Immersion depth : ance to soldering heat concert to soldering heat solder temperature Duration Immersed conditions Recovery Solder bath method Manual soldering Caution Recovery Solder bath method Manual soldering Caution Recovery Solder bath method	Up to 1.5mm from terminal root. 230.5 sc. 240.5 sc. 230.5 sc. 230.5 sc. 230.5 sc. 230.5 sc. 230.5 sc. 230.5 sc. 230.5 sc. 230.5 sc. 240.5 sc. 230.5 sc. 230.5 sc. 230.5 sc. 240.5 sc. 230.5 sc. 240.5 sc.
FL06BT       :         21. Resisita         LA Type         CAL45 Type         CAL45 Type         FBA/FBR         FL05         FL06BT Typ         [Test Metho         LA, CA         LHL         FB         FB	Immersion depth : Solder temperature : Duration depth : Solder temperature : Duration depth : Immersion depth : Immersion depth : Immersion depth : dand Remarks] Solder temperature Duration Immersed conditions Recovery Solder bath method Manual soldering Caution Recovery Solder bath method Manual soldering Caution Recovery Solder bath method	Up to 1.5mm from terminal root. 230.5 \$C 210.5 sec. Up to 2 to 2.5mm from terminal root. 230.5 \$C 331 sec. Up to 0.5 to 1.0mm from terminal root. 230.5 \$C 341 sec. Up to 0.5 to 1.0mm from terminal root. 230.5 \$C 341 sec. Up to 0.5 to 1.0mm from terminal root. 230.5 \$C 341 sec. Up to 0.5 to 1.0mm from terminal root. 230.5 \$C 240.5 \$C 24

22. Resisitance to solv	22. Resisitance to solvent				
LA Type		Please avoid the ultrasonic cleaning of this product.			
CAL45 Type					
LHL					
FBA/FBR		No significant abnormality in appearance	Impedance change : Within ±20%		
FL05 Type					
FL06BT Type					
Test Method and Rem					
FB : Solvent temperatu	ure : 20∼25℃				
Duration : 30±5 sec.					
Solvent type : Acetone, tri		chloroethylene			
Recovery : 3hrs of reco		overy under the standard condition after the test.			

#### 23 Thermal shock

20. Inerna shock			
LA Type	$\triangle$ L/L : Within ±10% Q : 30min		
CAL45 Type	$\triangle$ L/L : Within ±10%		
	Appearance : No abnormality	Inductance change : Within $\pm 10\%$	Q change : Within $\pm 30\%$ (LHLP : only $\triangle$ L/L)
FBA/FBR	Appearance : No abnormality	Impedance change : Within $\pm 20\%$	
FL05 Type	Refer to individual specification		
FL06BT Type	Appearance : No abnormality	Impedance change : Within $\pm 20\%$	

[Test Method and Remarks] LA, CA : Conditions for 1cycle

Step	Temperature (°C)	Duration (min.)
1	$-25^{+0}_{-3}$	30±3
2	Room temperature	Within 3
3	$+85^{+2}_{-0}$	30±3
4	Room temperature	Within 3
Number o	f cycles : 5 cycles	

Recovery : At least 1hr of recovery under the standard condition after the removal from test chamber, followed by the measurement within 2hrs.

## LHL . +FB : Accoding to JIS C0025 Conditions for 1 cycle

Step	Temperature (°C)	Duration (min.)
1	Minimum operating temperature <sup>+0</sup>	30±3
2	Room temperature	Within 3
3	Minimum operating temperature <sup>+2</sup>	30±3
4 Room temperature		Within 3
Number o	f cycles:10 cycles〔LHL□□□〕	

Recoverv

: 5 cycles (FBA, FBR) : 4 to 24hrs of recovery under the standard condition after the removal from the test chamber. (LHL : 3hrs of recovery under the standard condition after the removal from the test chamber. (FBA, FBR)

#### FL : Accoding to JIS C0025 Conditions for 1 cycle

Step	Temperature (°C)	Duration (min.)
1	$-25^{+0}_{-3}$	30±3
2	Room temperature	Within 3
3	$+85^{+2}_{-0}$	30±3
4	Room temperature	Within 3

Number of cycles : 10 cycles

: 1 to 2hrs of recovery under the standard condition after the removal from the test chamber. Recovery

24. Damp heat	
LA Type	△L/L : Within ±10% Q:30min
CAL45 Type	AL/L : Within ±10%
FBA/FBR	Appearance : No abnormality Impedance change : Within ±20%
FL05 Type	
FL06BT Type	
[Test Method and Remarks] LA, CA : Temperature : 40±2°C Humidity : 90~95%RH Duration : 1000 hrs Recovery : At least 1hr of r	ecovery under the standard removal from test chamber, followed by the measurement within 2hrs.
FB : Temperature : 60±2°C Humidity : 90~95%RH Duration : 1000 hrs Recovery : 1 to 2hrs of recover	y under the standard condition after the removal from the test chamber.

\* This catalog contains the typical specification only due to the limitation of space. When you consider purchase of our products, please check our specification. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (http://www.ty-top.com/) or CD catalogs.

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25. Loading under damp heat	
_А Туре	△L/L : Within ±10% Q : ±30min
CAL45 Type	△L/L : Within ±10%
	Appearance : No abnormality Inductance change : Within ±10% Q change : Within ±30% (LHLP : only △L/L)
FBA/FBR	
FL05 Type	Refer to individual specification
FL06BT Type	Appearance : No abnormality Impedance change : Within ±20%
Humidity : 9 Duration : 10 Applied current : R	0±2°C ~95%RH J00 hrs ated current t least 1hr of recovery under the standard removal from test chamber, followed by the measurement within 2hrs.
Humidity : 9 Duration : 10 Applied current : R	D±2°C D~95%RH 000±24 hrs ated current to 2hrs of recovery under the standard condition after the removal from the test chamber.
Humidity : 9 Duration : 5 Applied current : R	D±3°C D~95%RH D0 (+12, -0) hrs ated current to 2hrs of recovery under the standard condition after the removal from the test chamber.
26. Loading at high temperature	
LA Type	$\triangle$ L/L : Within ±10% Q : ±30min
CAL45 Type	△L/L : Within ±10%
FBA/FBR	
FL05 Type	
FL06BT Type	
Test Method and Remarks	
Duration : 10 Applied current : R	5±2°C )00 hrs ated current t least 1hr of recovery under the standard removal from test chamber, followed by the measurement within 2hrs.
27. Low temperature life test	
LA Type	△L/L : Within ±10% Q : ±30min
CAL45 Type	$\Delta L/L$ : Within ±10%
	Appearance : No abnormality Inductance change : Within ±10% Q change : Within ±30% (LHLP : only △L/L)
FBA/FBR	
FL05 Type	Refer to individual specification
FL06BT Type	Appearance : No abnormality Impedance change : Within ±20%
[Test Method and Remarks] LA, CA : Temperature : -29 Duration : 100 Recovery : At le	5±2°C 0 hrs sast 1hr of recovery under the standard removal from test chamber, followed by the measurement within 2hrs.
	$0\pm3^\circ\!\mathrm{C}$ $0\pm24$ hrs 2hrs of recovery under the standard condition after the removal from the test chamber.
	D±3°C (+12, -0) hrs 2hrs of recovery under the standard condition after the removal from the test chamber.
28. High temperature life test	
_А Туре	
CAL45 Type	
	Appearance : No abnormality Inductance change : Within ±10% Q change : Within ±30% (LHLP : only △L/L)
BA/FBR	
FL05 Type	Refer to individual specification
FL06BT Type	Appearance : No abnormality Impedance change : Within ±20%
[Test Method and Remarks] LHL	±3°C D±24 hrs 2hrs of recovery under the standard condition after the removal from the test chamber. 3°C
	(+12, -0) hrs 2hrs of recovery under the standard condition after the removal from the test chamber.

#### PRECAUTIONS

CAL Type, LH Type, FB Type, FL Type, LA Type

1. Circuit De	sian
On our De	♦Operating environment
Precautions	<ol> <li>The products described in this specification are intended for use in general electronic equipment, (office supply equipment, telecommunications systems, measuring equipment, and household equipment). They are not intended for use in mission-critical equipment or systems requiring special quality and high reliability (traffic systems, safety equipment, aerospace systems, nuclear control systems and medical equipment including life-support systems,) where product failure might result in loss of life, injury or damage. For such uses, contact TAIYO YUDEN Sales Department in advance.</li> </ol>
2. PCB Desi	gn
Precautions	◆Design
	1. Please design insertion pitches of a base in the pitches that fitted a terminal interval.
Technical consider- ations	Design 1. When Inductors are mounted onto a PC board, hole dimensions on the board should match the lead pitch of the component, if not, it will cause breakage of the terminals or cracking of terminal roots covered with resin as excess stress travels through the terminal legs.
3 Consider	ations for automatic placement
Precautions	Adjustment of mounting machine <ol> <li>Excessive impact load should not be imposed on the products when mounting onto the PC boards.</li> </ol>
Technical consider-	2. Mounting and soldering conditions should be checked beforehand.  Adjustment of mounting machine 1. When installing products, care should be taken not to apply distortion stress as it may deform the products.
ations	
4. Soldering	•
Precautions	<ul> <li>Wave soldering</li> <li>Please refer to the specifications in the catalog for a wave soldering.</li> <li>Do not immerse the entire Inductors in the flux during the soldering operation.</li> <li>Lead free soldering</li> <li>When using products with lead free soldering, we request to use them after confirming of adhesion, temperature of resistance to soldering heat, soldering etc sufficiently.</li> <li>Recommended conditions for using a soldering iron:</li> </ul>
	• Put the soldering iron on the land-pattern. • Soldering iron's temperature - Below 350°C • Duration - 3 seconds or less • The soldering iron should not directly touch the inductor. • Reflow soldering 1. As for reflow soldering, please contact our sales staff.
Technical consider- ations	Lead free soldering <ol> <li>If products are used beyond the range of the recommended conditions, heat stresses may deform the products, and consequently degrade the reliability of the products.</li> </ol>
5. Cleaning	
Precautions	<ul> <li>♦Cleaning conditions</li> <li>1. CAL type, LH type, LA Type</li> <li>Please do not do cleaning by a supersonic wave.</li> </ul>
Technical consider- ations	<ul> <li>Cleaning conditions</li> <li>CAL type, LH type, LA Type If washing by supersonic waves, supersonic waves may deform products.</li> </ul>
6. Handling	
Precautions	<ul> <li>◆Handling <ol> <li>Keep the inductors away from all magnets and magnetic objects.</li> <li>♦ Mechanical considerations <ol> <li>Please do not give the inductors any excessive mechanical shocks.</li> <li>H type </li> <li>If inductors are dropped onto the floor or a hard surface they should not be used.</li> </ol> </li> <li>♦ Packing <ol> <li>Please do not give the inductors any excessive mechanical shocks. </li> </ol> </li> </ol></li></ul>
Technical consider- ations	<ul> <li>♦ Handling</li> <li>1. There is a case that a characteristic varies with magnetic influence.</li> <li>♦ Mechanical considerations</li> <li>1. There is a case to be damaged by a mechanical shock.</li> <li>2. LH type</li> <li>There is a case to be broken by a fall.</li> <li>♦ Packing</li> <li>1. There is a case that a lead route turns by a fall or an excessive shock.</li> </ul>
7 Storage a	anditions
7. Storage c	<ul> <li>♦ Storage</li> <li>1. To maintain the solderability of terminal electrodes and to keep the packing material in good condition, temperature and humidity in the storage area should be controlled.</li> <li>Recommended conditions         <ul> <li>•Ambient temperature 0~40°C</li> <li>•Humidity Below 70% RH</li> <li>The ambient temperature must be kept below 30°C. Even under ideal storage conditions, solderability of products electrodes may decrease as time passes.</li> <li>For this reason, inductors should be used within one year from the time of delivery.</li> <li>In case of storage over 6 months, solderability shall be checked before actual usage.</li> </ul> </li> </ul>
Technical consider- ations	Storage of storage over o months, solderability shall be checked before actual usage.

\* This catalog contains the typical specification only due to the limitation of space. When you consider purchase of our products, please check our specification. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (http://www.ty-top.com/) or CD catalogs.

TAIYO YUDEN 2010